

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5583101

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TATSUYA OHTSUKA	02/02/2018
YOSHICHIKA KUROKI	02/07/2018
ATSUSHI SHIRAI	02/07/2018
MOE HOSOKAWA	02/07/2018
YOSUKE KISHIKAWA	02/13/2018
RECEIVING PARTY DATA	
Name:	DAIKIN INDUSTRIES, LTD.
Street Address:	UMEDA CENTER BUILDING
Internal Address:	4-12, NAKAZAKI-NISHI 2-CHOME, KITA-KU, OSAKA-SHI
City:	OSAKA
State/Country:	JAPAN
Postal Code:	5308323
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16471975
CORRESPONDENCE DATA	
Fax Number:	(202)721-8250
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	2019-1109A
NAME OF SUBMITTER:	KELLY GREENE
SIGNATURE:	/KELLY GREENE/
DATE SIGNED:	06/20/2019

Total Attachments: 2

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COMBINED DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN APPLICATION	
Title of Invention	METHOD FOR MANUFACTURING DIFLUOROMETHYLENE COMPOUND
<div style="text-align: center;">DECLARATION</div> <p>As a below named inventor, I hereby declare that:</p> <p>This declaration is directed to:</p> <p style="margin-left: 40px;"><input type="checkbox"/> The attached application, or</p> <p style="margin-left: 40px;"><input checked="" type="checkbox"/> United States application or PCT international application number <u>PCT/JP2017/046195</u> filed on <u>December 22, 2017</u>.</p> <p>The above-identified application was made or authorized to be made by me.</p> <p>I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.</p> <p>I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.</p> <p>Note to Inventor: 37 C.F.R. § 1.63(c) states: "A person may not execute an oath or declaration for an application unless that person has reviewed and understands the contents of the application, including the claims, and is aware of the duty to disclose to the Office all information known to the person to be material to patentability as defined in § 1.56."</p> <div style="text-align: center; padding: 10px 0;">ASSIGNMENT</div> <p>In consideration of the good and valuable consideration paid, I hereby sell and assign to</p> <p><u>DAIKIN INDUSTRIES, LTD.</u> (Name of Assignee)</p> <p>of <u>Umeda Center Building, 4-12, Nakazaki-Nishi 2-Chome, Kita-ku, Osaka-shi, Osaka 5308323, Japan</u> (Address of Assignee)</p> <p>(hereinafter designated as the Assignee) my entire right, title and interest for the United States as defined in 35 USC 100, for any invention set forth in the above-identified application.</p> <p>I agree to execute all papers necessary in connection with this application for patent in the USPTO for the invention, and any continuation, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.</p> <p>I agree to execute all papers necessary in connection with any post-grant proceeding which may occur in connection with this application or continuation, divisional or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such post-grant proceeding.</p> <p>The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar</p>	

agreements, which includes the right to claim priority and the right to be granted a patent in any PCT Contracting State.

I agree to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

I hereby authorize and request the USPTO to issue any and all Letters Patents of the United States resulting from the application or any continuation, divisional or reissue applications thereof to the Assignee, as Assignee of my entire interest, and covenant that I have not executed, and will not execute, any agreement in conflict herewith.

First Inventor (Legal Name): Tatsuya OHTSUKA

Signature: Tatsuya Ohtsuka

Date: February 2, 2018

Second Inventor (Legal Name): Yoshichika KUROKI

Signature: Yoshichika Kuroki

Date: February 7, 2018

Third Inventor (Legal Name): Atsushi SHIRAI

Signature: Atsushi Shirai

Date: February 7, 2018

Fourth Inventor (Legal Name): Moe HOSOKAWA

Signature: Moe Hosokawa

Date: February 7, 2018

Fifth Inventor (Legal Name): Yosuke KISHIKAWA

Signature: Yosuke Kishikawa

Date: February 13, 2018

Sixth Inventor (Legal Name): _____

Signature: _____

Date: _____

Seventh Inventor (Legal Name): _____

Signature: _____

Date: _____

Eighth Inventor (Legal Name): _____

Signature: _____

Date: _____